IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Cyril Cabral, Jr., et al.

Examiner:

Unassigned

Serial No:

Unassigned

Art Unit:

Unassigned

Filed:

Herewith

Docket:

YOR919990509US3 (13171AB)

For: METHOD AND STRUCTURE

Date:

April 19, 2004

FOR REDUCTION OF CONTACT RESISTANCE OF METAL SILICIDES **USING A METAL-GERMANIUM ALLOY**

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

Sir:

In accordance with 37 C.F.R. §§1.56, 1.97 and 1.98, it is respectfully requested that the following references, which are also listed on the attached form PTO-1449, be made of record in the above-identified patent application.

- U.S. Patent No. 5,510,295, dated April 23, 1996, issued to Cabral Jr., 1. et al.;
- U.S. Patent No. 5,608,226, dated March 4, 1997, issued to Yamada, et 2. al.;

CERTIFICATE OF MAILING BY "EXPRESS MAIL"

"Express Mail" Mailing Label Number: EV 213899804US Date of Deposit: April 19, 2004

I hereby certify that this correspondence is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under/37 C.F./R. §1.10 on the date indicated above and is addressed to the Commission of for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Dated: April 19, 2004

- 3. U.S. Patent No. 5,624,869, dated April 29, 1997, issued to Agnello, et al.;
- 4. U.S. Patent No. 5,828,131, dated October 27, 1998, issued to Cabral, Jr., et al.
- 5. U.S. Patent No. 5,830,775, dated November, 1998, issued to Maa, et al.
- 6. U.S. Patent No. 5,710,450, dated January, 1998, issued to Chau, et al.
- 7. U.S. Patent No. 6,121,100, dated September, 2000, issued to Andideh, et al.
- 8. U.S. Patent No. 6,165,826, dated December, 2000, issued to Chau, et al.
- 9. U.S. Patent No. 6,211,560 B1, dated April, 2001, issued to Jimenez, et al.
- 10. U.S. Patent No. 6,326,664 B1, dated December, 2001, issued to Chau, et al.
- 11. U.S. Patent No. 4,965,645 A, dated October, 1990, issued to Solomon.
- 12. U.S. Patent No. 5,336,903 A, dated August, 1994, issued to Ozturk, et al.
- 13. U.S. Patent No. 5,401,674 A, dated March, 1995, issued to Anjum, et al
- 14. M. Lawrence, et al., "Growth of Epitaxial CoSi₂ on (100) Si, "Appl. Phys. Lett., Vol. 58, No. 12, pp. 1308-1310 (1991).
- 15. C. Cabral, et al., "In-Situ X-Ray Diffractin and Resistivity Analysis of CoSi₂ Phase Formation With and Without a Ti Interlayer at Rapid Thermal Annealing Rates, "Mat. Res. Soc. Symp. Proc., Vol. 375, pp. 253-258 (1995).
- 16. Wolf, Silicon Processing for the VLSI Era, Vol. 2-Process Integration, Lattice Press: Sunset Beach CA, 1990, pp. 144-151.
- 17. Huang, et al. "Impact of Ge implantation on the electrical characteristics of TiSi2 p+n shallow junctions with an a-Si (or poly-

Si) buffer layer" in IEEE Transactions on Electron Devices, 44(4),

April 1997, pp. 601-606.

18. Prabhakaran, et al. "Diffusion mediated chemical reaction in

Co/Ge/Si(100) forming Ge/CoSi₂/Si(100)" in Applied Physics Letters

68(9), 26 February 1996, pp. 1241-1243.

Pursuant to 37 C.F.R. §1.98(d), copies of the above listed references are not

provided, as the references were previously submitted to the Examiner or cited by the

Examiner in connection with parent case, Serial No. 09/519,897 filed April 6, 2000 and

divisional application Serial No. 09/994,954 filed November 27, 2001.

Consideration of this Information Disclosure Statement is respectfully requested,

since the information provided herewith may be material to the examination of the present

application as defined under 37 C.F.R. §1.56. This statement is not intended to represent

that a search has been performed or that no other art than that identified herein exists.

The instant Information Disclosure Statement is being submitted concurrent with the

filing of the present application. Therefore, this filing is made under 37 C.F.R. §1.97(b)(1).

An Information Disclosure Statement filed under 37 C.F.R. §1.97(b)(1) requires neither

certification nor fee.

Respectfull submitte

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LSS:HAH:kc

INFORMATION DISCLOSURE CITATION (Use several sheets if necessary)				Docket Number (Optional) YOR919990509US3 (13171AB) Applicant(s) Cyril Cabral, Jr., et al.									
			Filing Date Herewith	Group Art Unit Unassigned									
		<u></u>	U.S. PATENT	DOCUMENTS									
*EXAMINER INITIAL	REF	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE						
		5,510,295	4/23/96	Cabral, Jr., et al.									
		5,608,226	3/4/97	Yamada, et al.									
		5,624,869	4/29/97	Agnello, et al.									
		5,828,131	10/27/98	Cabral, Jr., et al.									
		5,830,775	11/1998	Maa, et al.									
		5,710,450	1/1998	Chau, et al.									
		6,121,100	9/2000	Andideh, et al.									
		6,165,826	12/2000	Chau, et al.									
		6,211,560 B1	4/2001	Jimenez, et al.									
		6,326,664 B1	12/2001	Chau, et al.		·							
		.	FOREIGN PATE	ENT DOCUMENTS									
	REF	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES NO						
							183						
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		OTHER DOCU	MENTS (Including A	Author, Title, Date, Pertinent Pag	ges, Etc.)								
		M. Lawrence, et a Phys. Lett., Vol.					i, "App	ol.					
		Wolf, Silicon Processing for the VLSI Era, Vol. 2-Process Intergration, Lattice Press: Sunset Beach CA, 1990, pp. 144-151.											
		C. Cabral, et al., "In-Situ X-Ray Diffractin and Resistivity Analysis of CoSi2 Phase Formation With and Without a Ti Interlayer at Rapid Thermal Annealing Rates, "Mat. Res. Soc. Symp. Proc., Vol. 375, pp. 253-258 (1995).											
EXAMINER			DATE CONSIDERED										
		citation considered, whether or not one of this form with next communications.		Lance with MPEP 609; Draw lin	e through c	itation if not in	conformance	and not					

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			U.S. PATENT	DOCUMENTS	, 							
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		4,965,645 A	10/1990	Solomon.								
		5,336,903 A	8/1994	Ozturk, et al.								
		5,401,674 A	3/1995	Anjum, et al.								
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			FOREIGN PATE	ENT DOCUMENTS								
					5		TRANSLA	TION				
	REF	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	YES	NO				
	4	OTHER DOCUM	IENTS (Including A	uthor, Title, Date, Pertinent Pa	ges, Etc.)							
	Huang, et al. "Impact of Ge implantation on the electrical characteristics of TiSi2 p+n shallow junctions with an a-Si (or poly-Si) buffer layer" in IEEE Transactions on Electron Devices, 44(4), April 1997, pp. 601-606.											
		Prabhakaran, et al. "Diffusion mediated chemical reaction in Co/Ge/Si(100) forming Ge/CoSi2/Si(100)" in Applied Physics Letters 68(9), 26 February 1996, pp. 1241-1243.										
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